

# **NT93-s**

# Non-Silicone Thermal Conductive RF Absorber Pad

LiPOLY NT93-s is a thermally conductive absorber based upon soft magnetic materials dispersed in a non-silicone resin. It has a thermal conductivity of 3.0 W/m\*K and dissipates electromagnetic radiation rapidly to mitigate against EMI issues.

#### **■ FEATURES**

/ Thermal conductivity: 3.0 W/m\*K / Excellent absorption

characteristics

/ Naturally tacky

/ Reworkable

#### **■ TYPICAL APPLICATION**

/ IC, CPU, MOS, LED, M/B, Heat sink / LCD-TV, Notebook PC, PC, Telecom device, Wireless hub / DDR II module, DVD applications,

Hand-set applications

/ 5G base station & infrastructure

/ EV electric vehicle

#### SPECIFICATIONS

/ Sheet form / Die-cut parts

## **■ FREQUENCY APPLICATION**

2.4 GHz Wi-Fi Router, Bluetooth

3.5 GHz 5G Mobile Networks

5.0 GHz Wi-Fi Router 6.0 GHz Wi-Fi Router

12~18 GHz Low Earth Orbit (LEO) System

28 GHz 5G Mobile Networks 39 GHz 5G Mobile Networks

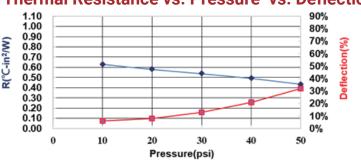
#### **■ TYPICAL PROPERTIES**

	PROPERTY	NT93-s	TEST METHOD	UNIT
	Color	Dark Gray	Visual	-
	Surface tack 2-side/1-side	2	-	-
	Thickness	Customized	ASTM D374	mm
	Density	3.7	ASTM D792	g/cm³
	Hardness	65	ASTM D2240	Shore OO
	Application temperature	-60~125	-	°C
	ROHS & REACH	Compliant	-	-
	COMPRESSION@1.0mm			
	Deflection @10 psi	6	ASTM D5470 modify	%
	Deflection @20 psi	8	ASTM D5470 modify	%
	Deflection @30 psi	13	ASTM D5470 modify	%
	Deflection @40 psi	21	ASTM D5470 modify	%
	Deflection @50 psi	32	ASTM D5470 modify	%
	EMI Attenuation @1.0mm			
	EMI attenuation@ 2.4 GHz	12	ASTM D4935 modify	dB/cm
	EMI attenuation@ 3.5 GHz	14	ASTM D4935 modify	dB/cm
	EMI attenuation@ 5.0 GHz	29	ASTM D4935 modify	dB/cm
	EMI attenuation@ 6.0 GHz	25	ASTM D4935 modify	dB/cm
	EMI attenuation@ 12 GHz	60	ASTM D4935 modify	dB/cm
	EMI attenuation@ 18 GHz	71	ASTM D4935 modify	dB/cm
	EMI attenuation@ 28 GHz	112	ASTM D4935 modify	dB/cm
	EMI attenuation@ 39 GHz	68	ASTM D4935 modify	dB/cm
	ELECTRICAL			
	Surface resistivity	>1011	ASTM D257	Ohm
	Volume resistivity	>1010	ASTM D257	Ohm-m
	THERMAL			
	Thermal Conductivity	3.0	ASTM D5470	W/m*K
	Thermal impedance@10 psi	0.632	ASTM D5470	°C-in²/ W
	Thermal impedance@20 psi	0.581	ASTM D5470	°C-in²/ W
	Thermal impedance@30 psi	0.539	ASTM D5470	°C-in²/ W
_	Thermal impedance@40 psi	0.493	ASTM D5470	°C-in²/ W
	Thermal impedance@50 psi	0.436	ASTM D5470	°C-in²/ W

## **Attenuation**

# 400 300 200 100 25 Frequency (GHz)

## Thermal Resistance vs. Pressure vs. Deflection



Note: All specifications provided by LiPOLY are subject to change without notice. The test methods used Note: All specifications provided by LIPOLY are subject to change without notice. The test methods used

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